STPS1545-Y



Automotive power Schottky rectifier

Datasheet - production data

Features

- very small conduction losses
- negligible switching losses
- extremely fast switching
- avalanche capability specified
- AECQ-101 qualified
- ECOPACK®2 compliant component

Description

Single chip schottky rectifier suited for switch mode power supply and high frequency DC to DC converters.

Packaged in TO-220AC, this device is especially intended for use in low voltage, high frequency inverters, free wheeling and polarity protection in automotive applications.

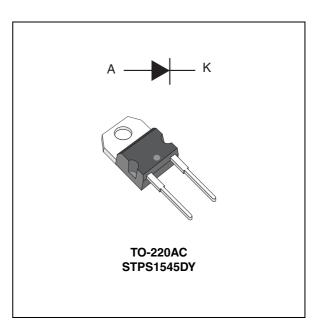


Table 1. Device summary

Symbol	Value		
I _{F(AV)}	15 A		
V _{RRM}	45 V		
T _j (max)	175 °C		
V _F (max)	0.57 V		

STPS1545-Y **Characteristics**

Characteristics

Table 2. **Absolute ratings (limiting values)**

Symbol	Paramete	Value	Unit	
V_{RRM}	Repetitive peak reverse voltage		45	V
I _{F(RMS)}	Forward rms current		30	Α
I _{F(AV)}	Average forward current $\delta = 0.5$	T _c = 155 °C	15	Α
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal	220	Α
I _{RRM}	Peak repetitive reverse current	t _p = 2 μs square F = 1 kHz	1	Α
I _{RSM}	Non repetitive peak reverse current	t _p = 100 μs square	3	Α
P _{ARM}	Repetitive peak avalanche power	$t_p = 1 \mu s T_j = 25 °C$	6000	W
T _{stg}	Storage temperature range		-65 to + 175	°C
Tj	Operating junction temperature (1)		-40 to + 175	°C
dV/dt	Critical rate of rise of reverse voltage		10000	V/µs

^{1.} $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter	Value	Unit
R _{th(j-c)}	Junction to case	1.6	°C/W

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V _R =V _{RRM}	-	-	200	μΑ
		T _j = 125 °C		-	11	40	mA
V _F ⁽¹⁾	Forward voltage drop	T _j = 125°C	I _F = 15A	-	0.5	0.57	
		T _j = 25°C	I _F = 30 A	-	-	0.84	V
		T _j = 125 °C	I _F = 30 A	-	0.65	0.72	

^{1.} Pulse test: t_p = 380 μ s, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.42 x $I_{F(AV)}$ + 0.01 $I_{F}^{2}_{(RMS)}$

$$P = 0.42 \times I_{E(A)(1)} + 0.01 I_{E}^{2} (PMC)$$

STPS1545-Y Characteristics

Figure 1. Average forward power dissipation Figure 2. Average forward current versus versus average forward current ambient temperature (δ = 0.5)

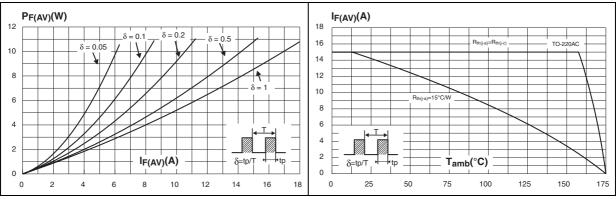


Figure 3. Normalized avalanche power derating versus pulse duration

Figure 4. Normalized avalanche power derating versus junction temperature

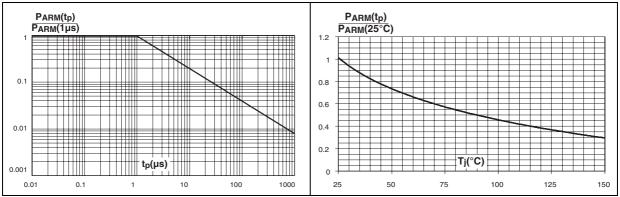
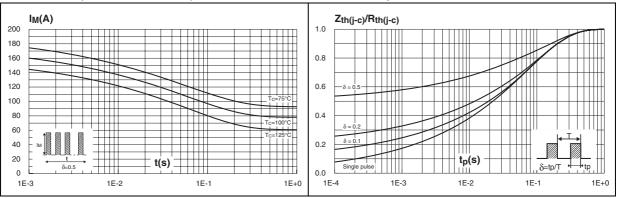


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)

Figure 6. Relative variation of thermal impedance junction to case versus pulse duration



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Figure 7. Reverse leakage current versus reverse voltage applied (typical values)

Figure 8. Junction capacitance versus reverse voltage applied (typical values)

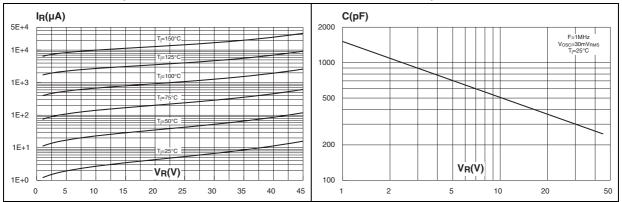
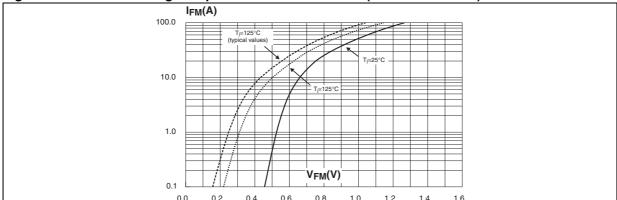


Figure 9. Forward voltage drop versus forward current (maximum values)

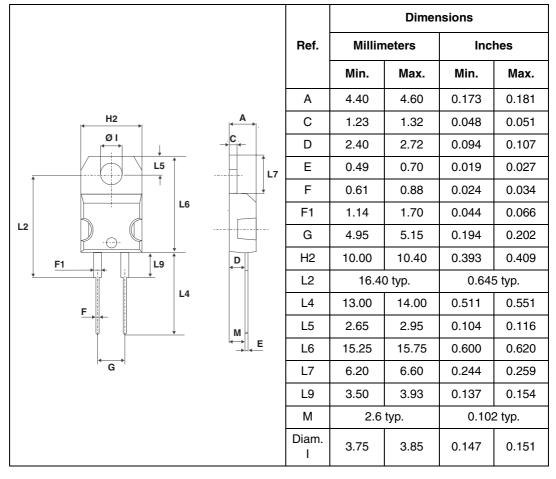


2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 0.4 to 0.6 N⋅m

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. TO-220AC Dimensions



Ordering information STPS1545-Y

3 Ordering information

 Table 6.
 Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS1545DY	STPS1545DY	TO-220AC	1.86 g	50	Tube

4 Revision history

Table 7. Document revision history

Date	Revision	Changes
29-Oct-2012	1	First issue.

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